

International IOR Rectifier

SERIES IRK.F180

FAST SCR / DIODE and SCR / SCR

MAGN-A-pak™ Power Modules

Features

- Fast turn-off thyristor
- Fast recovery diode
- High surge capability
- Electrically isolated baseplate
- 3000V_{RMS} isolating voltage
- Industrial standard package

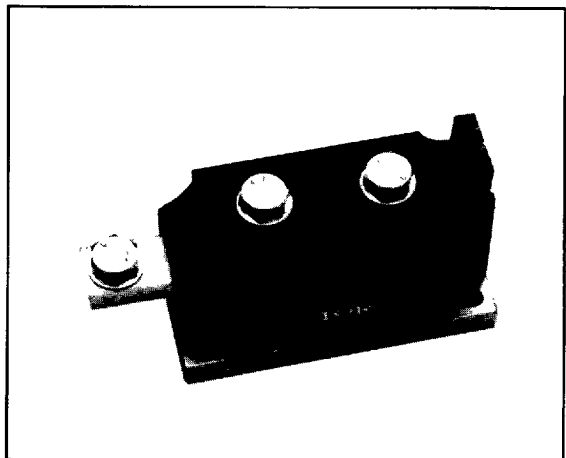
180A

Description

These series of MAGN-A-pak modules are intended for applications such as self-commutated inverters, DC choppers, electronic welders, induction heating and others where fast switching characteristics are required.

Major Ratings and Characteristics

Parameters	Value	Units
$I_{T(AV)}$	180	A
@ T_C	85	°C
$I_{T(RMS)}$	400	A
I_{TSM} @ 50Hz	7130	A
@ 60Hz	7470	A
I^2_t @ 50Hz	255	kA ² s
@ 60Hz	232	kA ² s
$I^2\sqrt{t}$	2550	kA ² /s
V_{TM}	1.84	V
V_{RRM}/V_{DRM}	200 to 1200	V
t_q range	18 to 25	μs
t_{rr} (diode)	2 max	μs
T_J	-40 to 125	°C
V_{INS}	3000	V



ELECTRICAL SPECIFICATIONS

Voltage Ratings

Part number (*)	Voltage code	V_{RRM} , maximum repetitive peak reverse voltage (V)	V_{DRM} , maximum repetitive peak off-state voltage (V)	I_{RRM} , I_{DRM} max @ 125°C (mA)
IRKT/H/L/U/V/K/NF180	02	200	200	50
	04	400	400	50
	06	600	600	50
	08	800	800	50
	10	1000	1000	50
	12	1200	1200	50

(*) Refer to Ordering Information Table to complete Part number

Current Carrying Capacity

Frequency f				Units			
50Hz	370	530	565	800	2400	3150	A
400Hz	435	650	670	1000	1540	2050	A
2500Hz	290	430	490	720	610	830	A
5000Hz	240	345	390	540	390	540	A
10000Hz	170	270	290	390	-	-	A
Recovery voltage Vr	50	50	50	50	50	50	V
Voltage before turn-on Vd	80% V _{DRM}		80% V _{DRM}		80% V _{DRM}		V
Rise of on-state current di/dt	50	50	-	-	-	-	A/µs
Case temperature	85	60	85	60	85	60	°C
Equivalent values for RC circuit	10Ω/0.47µF		10Ω/0.47µF		10Ω/0.47µF		

On-state Conduction

Parameters		Values	Units	Conditions		
$I_{T(AV)}$	Max. average on-state current	180	A	180° sinusoidal conduction Max. case temperature $T_c = 85^{\circ}\text{C}$		
$I_{T(RMS)}$	Maximum RMS current	400	A	as AC switch		
I_{TSM}	Maximum peak one half cycle non repetitive surge current	7130	A	10ms	No voltage reapplied	Sinusoidal half Wave Initial $T_j = 125^{\circ}\text{C}$
		7470	A	8.3ms		
		6000	A	10ms	100% V_{RRM} reapplied	Sinusoidal half Wave Initial $T_j = 125^{\circ}\text{C}$
		6280	A	8.3ms		
I^2t	Maximum I^2t for fusing	255	kA^2s	10ms	No voltage reapplied	Initial $T_j = 125^{\circ}\text{C}$
		232	kA^2s	8.3ms		
		180	kA^2s	10ms	100% V_{RRM} reapplied	Initial $T_j = 125^{\circ}\text{C}$
		164	kA^2s	8.3ms		
I^2/t	Maximum I^2/t for fusing	2550	kA^2/s	t=0 to 10ms, no voltage reapplied Initial $T_j = 125^{\circ}\text{C}$		

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65E D

On-state Conduction

Parameters	Values	Units	Conditions
V_{TM} Max. peak on-state voltage	1.84	V	$I_T = 600A$ (peak) half sine wave, $T_J = T_{Jmax}$, $t_p = 10ms$
$V_{T(TO)1}$ Low level value of threshold voltage	1.30	V	$T_J = 125^\circ C$ ($16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$)
$V_{T(TO)2}$ High level value of threshold voltage	1.38	V	$T_J = 125^\circ C$ ($\pi \times I_{T(AV)} < I < 20 \times \pi \times I_{T(AV)}$)
r_{t1} Low level value of on-state slope resistance	0.90	m Ω	$T_J = 125^\circ C$ ($16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$)
r_{t2} High level value of on-state slope resistance	0.710	m Ω	$T_J = 125^\circ C$ ($\pi \times I_{T(AV)} < I < 20 \times \pi \times I_{T(AV)}$)
I_H Maximum holding current	600	mA	$T_J = 25^\circ C$, $I_T > 30A$
I_L Latching current	1000	mA	$T_J = 25^\circ C$, $V_A = 12V$, $R_a = 6\Omega$, $I_g = 1A$

Triggering

Parameters	Values	Units	Conditions
P_{GM} Maximum peak gate power	60	W	$f = 50$ Hz, $d\% = 50$
$P_{G(AV)}$ Maximum average gate power	10	W	$T_J = 125^\circ C$, $f = 50$ Hz, $d\% = 50$
I_{GM} Maximum peak gate current	10	A	$T_J = 125^\circ C$, $t_p \leq 5ms$
$-V_{GM}$ Maximum peak negative gate voltage	5	V	$T_J = 125^\circ C$, $t_p \leq 5ms$
V_{GT} Maximum gate voltage required to fire all devices	3	V	$T_J = 25^\circ C$, $V_A = 12V$, $R_a = 6\Omega$
I_{GT} Maximum gate current required to fire all devices	200	mA	$T_J = 25^\circ C$, $V_A = 12V$, $R_a = 6\Omega$
V_{GD} Maximum gate voltage	0.25	V	$T_J = 125^\circ C$, rated V_{DRM} applied
I_{GD} Maximum gate current that will not trigger any device	20	mA	$T_J = 125^\circ C$, rated V_{DRM} applied

Blocking

dv/dt Maximum critical rate of rise of off-state voltage	400	V/ μs	$T_J = 125^\circ C$ linear to 80% V_{DRM} (*)
I_{RRM} I_{DRM} Max. peak reverse and off-state leakage current	30	mA	$T_J = 125^\circ C$ rated V_{DRM} , V_{RRM} applied
V_{INS} RMS isolation voltage	3000	V	50 Hz, circuit to base, $T_J = 25^\circ C$, 1s

(*) Contact factory for other selections

Switching

t_q Maximum turn-off time	P	K	J	$I_T = 750A$, $T_J = 125^\circ C$ $-di/dt = 25 A/\mu s$ $V_R = 50V$ $dv/dt = 50 V/\mu s$ linear to 80% V_{DRM}
	18	20	25	μs
t_{rr} Maximum recovery time	2			μs $I_T = 350A$, $-di/dt = 25 A/\mu s$, $V_R = 50V$, $T_J = 25^\circ C$
di/dt Max. non-repetitive rate of rise	800			A/ μs Gate drive 20V, 20 Ω , $t_r \leq 1\mu s$, $V_D = 80\% V_{DRM}$ $T_J = 125^\circ C$

Thermal and Mechanical Specifications

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T_J	Junction temperature range	-40 to 125	°C	
T_{stg}	Storage temperature range	-40 to 150	°C	
R_{thJC}	Internal thermal resistance, junction to case	0.125	K/W	DC operation per junction
R_{thCS}	Thermal resistance case to sink	0.025	K/W	Mounting surface flat and greased - Per module
T	Mounting torque, $\pm 10\%$	4 to 6	Nm	A mounting compound is recommended. The torque should be rechecked after a period of about 3 hours to allow for the spread of the compound. Use of cable lugs is not recommended, busbars should be used and restrained during tightening. Threads must be lubricated with a compound.
	MAGN-A-pak to heatsink	35 to 53	lb * in	
	Busbar to MAGN-A-pak	8 to 10	Nm	
		70 to 90	lb * in	
wt	Approximate weight	850/30	g/oz	
	Case style	MAGN-A-pak		See Outline Table

 ΔR Conduction (per Junction)

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.009	0.006	K/W	$T_J = T_J \text{ max.}$
120°	0.010	0.011	K/W	
90°	0.014	0.015	K/W	
60°	0.020	0.020	K/W	
30°	0.032	0.033	K/W	

Ordering Information Table

Device Code						
1	2	3	4	5	6	7
IRK	T	F	180	-	12	H J
1	Module type					
2	Circuit configuration (See Circuit Configuration Table)					
3	Fast SCR					
4	Current rating					
5	Voltage code: Code x 100 = V_{RRM}					
6	dv/dt code (See table)					
7	tq code (See table)					

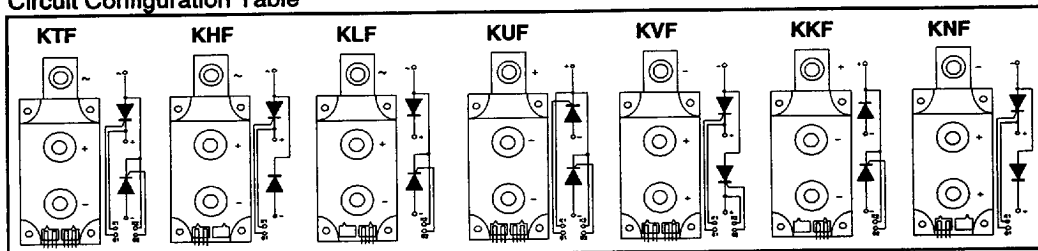
tq

P $\leq 18\mu s$
K $\leq 20\mu s$
J $\leq 25\mu s$

dv/dt

C = 20V/ μs
D = 50V/ μs
For the following selections
contact factory
E = 100V/ μs
F = 200V/ μs
G = 300V/ μs
H = 400V/ μs

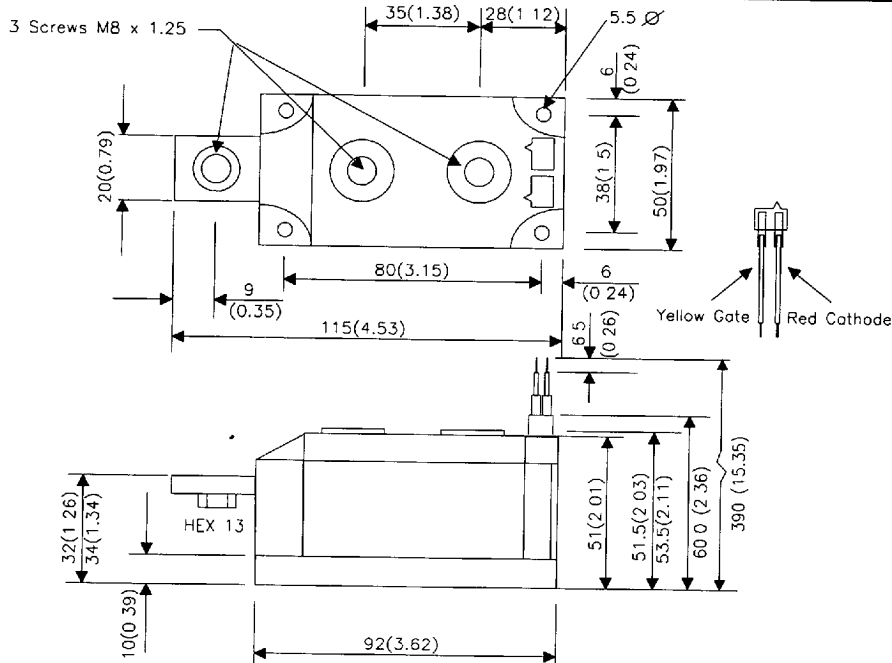
Circuit Configuration Table



Outline Table

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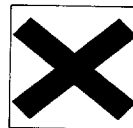
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- All dimensions in millimeters (inches)
- Dimensions are nominal
- Full engineering drawings are available on request
- UL identification number for gate and cathode wire: UL 1385
- UL identification number for package: UL 94V0

CONTAINS BERYLLIUM OXIDE CERAMIC

- May contain Beryllium Oxide Ceramic, and under normal circumstances is non hazardous
- Do not open, cut or grind
- Unserviceable parts must be disposed of as harmful waste



HARMFUL

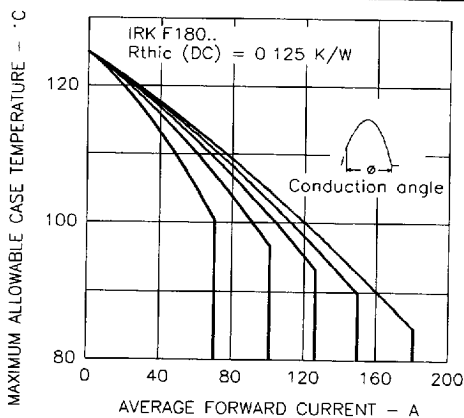


Fig. 1 - Current Ratings Characteristics

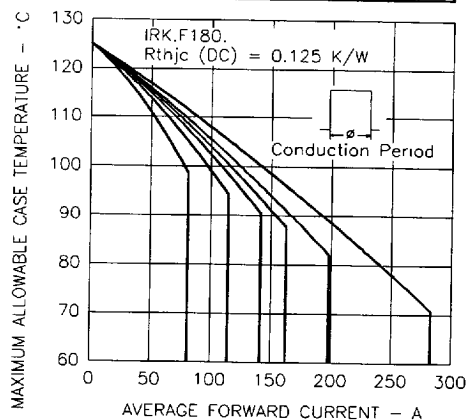


Fig. 2 - Current Ratings Characteristics

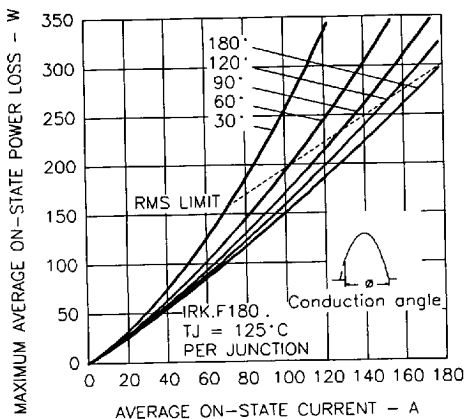


Fig. 3 - On-state Power Loss Characteristics

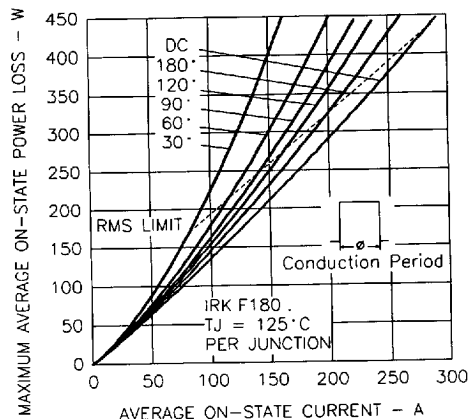


Fig. 4 - On-state Power Loss Characteristics

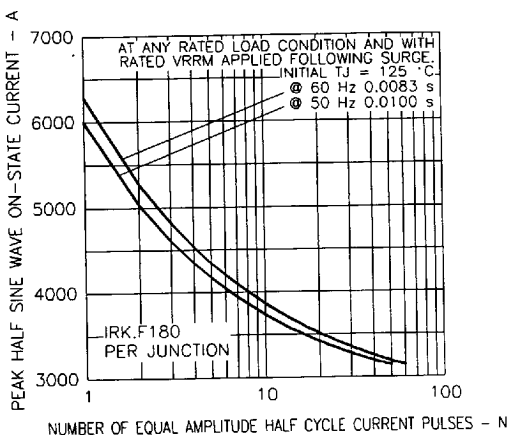


Fig. 5 - Maximum Non-Repetitive Surge Current

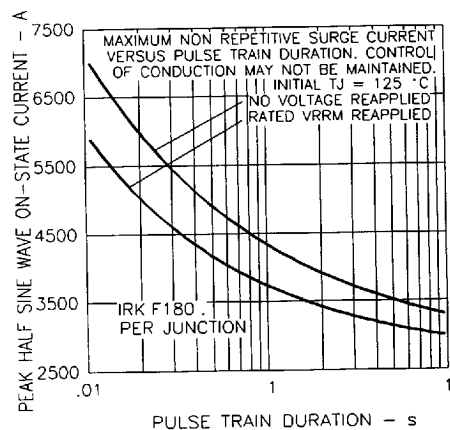


Fig. 6 - Maximum Non-Repetitive Surge Current

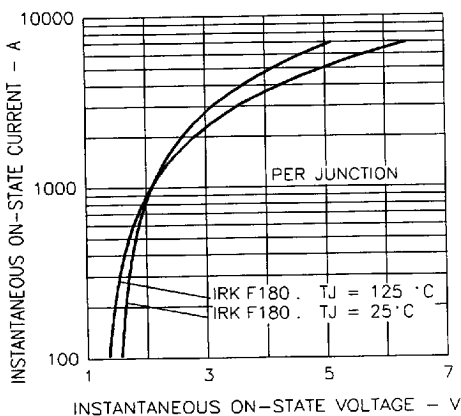


Fig. 7 - On-state Voltage Drop Characteristics

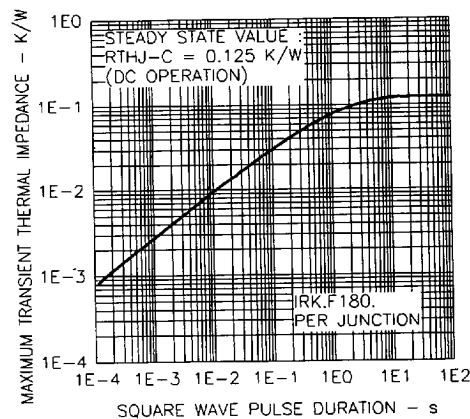


Fig. 8 - Thermal Impedance ZthJC Characteristics

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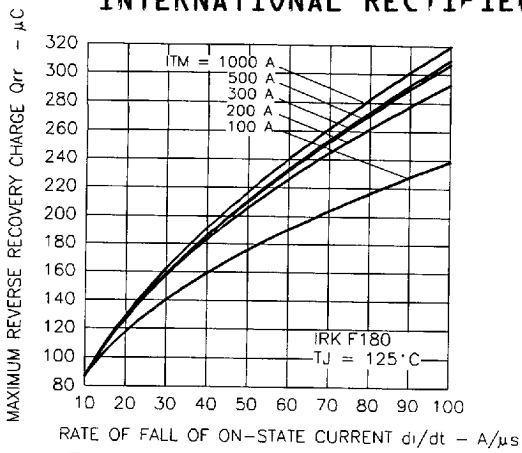


Fig. 9 - Reverse Recovery Charge Characteristics (Thyristor)

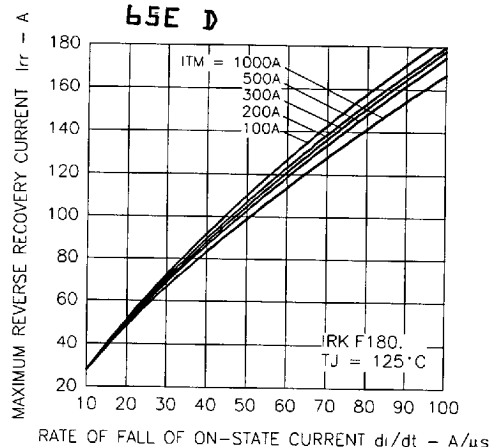


Fig. 10 - Reverse Recovery Current Characteristics (Thyristor)

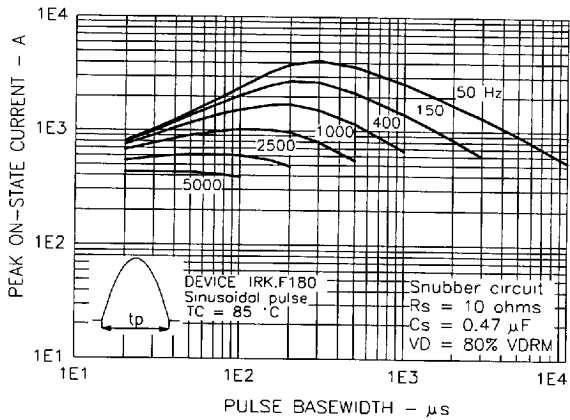


Fig. 11 - Frequency Characteristics

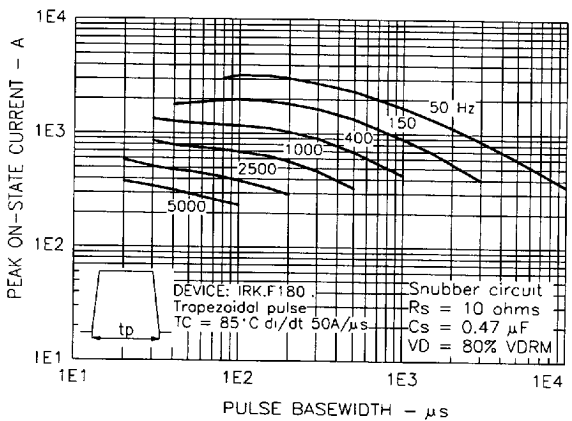
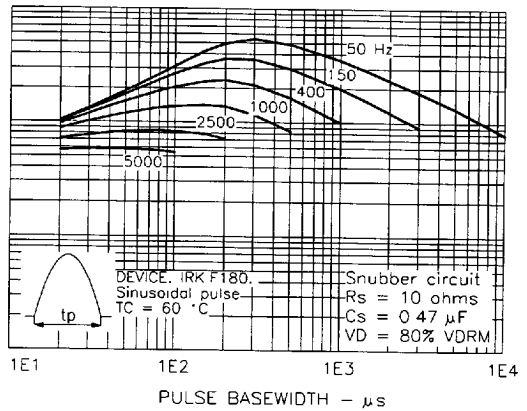
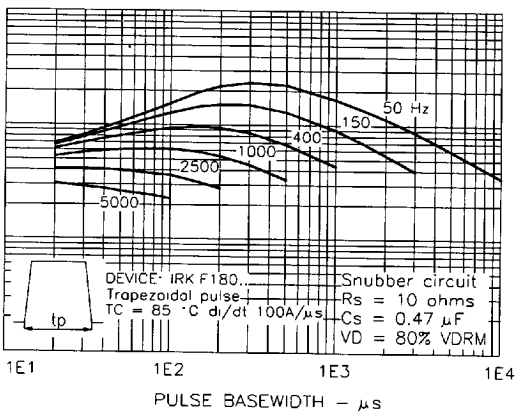


Fig. 12 - Frequency Characteristics



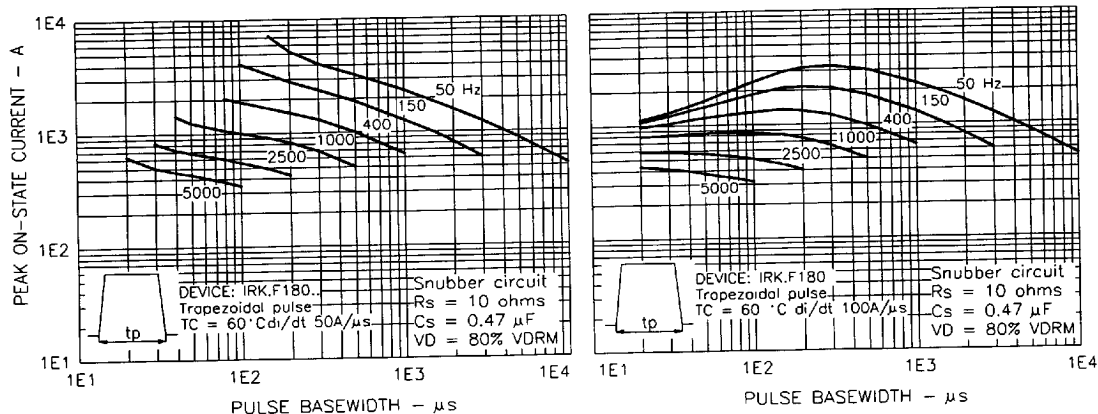


Fig. 13 - Frequency Characteristics

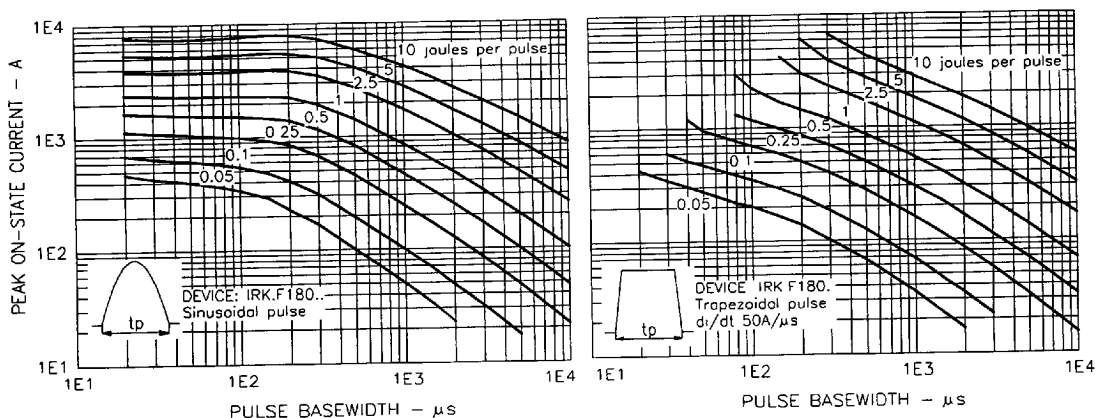


Fig. 14 - Maximum On-state Energy Power Loss Characteristics

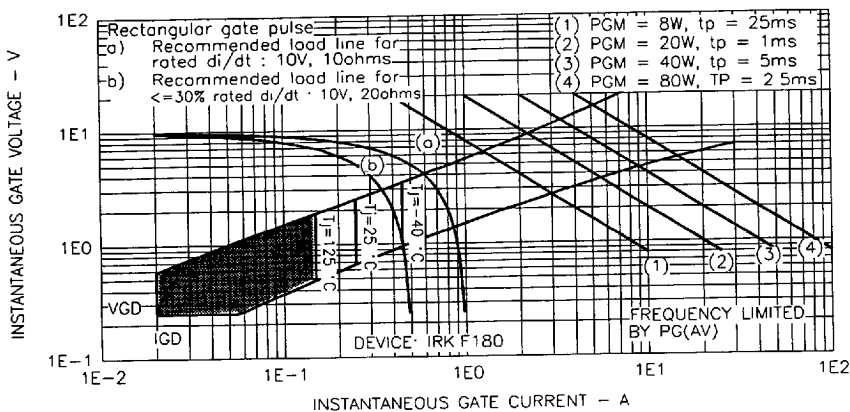


Fig. 15 - Gate Characteristics